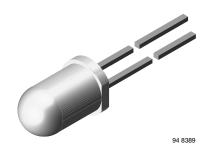


Vishay Semiconductors

# High Speed Infrared Emitting Diode, 830 nm, GaAIAs Double Hetero



# FEATURES

- Package type: leaded
- Package form: T-1¾
- Dimensions (in mm):  $\emptyset$  5
- Peak wavelength:  $\lambda_p = 830 \text{ nm}$
- High reliability
- High radiant power
- High radiant intensity
- Angle of half intensity:  $\phi = \pm 10^{\circ}$
- Low forward voltage
- · Suitable for high pulse current operation
- High modulation bandwidth: f<sub>c</sub> = 18 MHz
- · Good spectral matching with CMOS cameras
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

### APPLICATIONS

- Infrared radiation source for operation with CMOS cameras (illumination)
- High speed IR data transmission
- · Smoke-automatic fire detectors

#### DESCRIPTION

TSHG8200 is an infrared, 830 nm emitting diode in GaAlAs double hetero (DH) technology with high radiant power and high speed, molded in a clear, untinted plastic package.

### **PRODUCT SUMMARY**

COMPONENT	l <sub>e</sub> (mW/sr)	φ <b>(deg)</b>	λ <sub>P</sub> (nm)	t <sub>r</sub> (ns)
TSHG8200	180	± 10	830	20

#### Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMAT	ΓΙΟΝ		
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TSHG8200	Bulk	MOQ: 4000 pcs, 4000 pcs/bulk	T-1¾

#### Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V <sub>R</sub>	5	V
Forward current		١ <sub>F</sub>	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I <sub>FM</sub>	200	mA
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1	А
Power dissipation		Pv	180	mW
Junction temperature		Тj	100	°C
Operating temperature range		T <sub>amb</sub>	- 40 to + 85	°C
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C
Soldering temperature	$t \leq$ 5 s, 2 mm from case	T <sub>sd</sub>	260	°C
Thermal resistance junction/ambient	J-STD-051, leads 7 mm soldered on PCB	R <sub>thJA</sub>	230	K/W

#### Note

T<sub>amb</sub> = 25 °C, unless otherwise specified

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FREE

# **TSHG8200**

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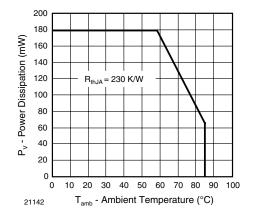


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

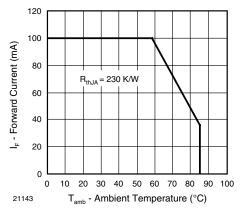


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms	V <sub>F</sub>		1.5	1.8	V
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	V <sub>F</sub>		2.3		V
Temperature coefficient of $V_F$	I <sub>F</sub> = 1 mA	TK <sub>VF</sub>		- 1.8		mV/K
Reverse current	V <sub>R</sub> = 5 V	I <sub>R</sub>			10	μA
Junction capacitance	V <sub>R</sub> = 0 V, f = 1 MHz, E = 0	Cj		125		pF
Radiant intensity	I <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms	le	120	180	360	mW/sr
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	l <sub>e</sub>		1600		mW/sr
Radiant power	l <sub>F</sub> = 100 mA, t <sub>p</sub> = 20 ms	φ <sub>e</sub>		50		mW
Temperature coefficient of $\phi_{\text{e}}$	I <sub>F</sub> = 100 mA	TKφe		- 0.35		%/K
Angle of half intensity		φ		± 10		deg
Peak wavelength	I <sub>F</sub> = 100 mA	λρ		830		nm
Spectral bandwidth	I <sub>F</sub> = 100 mA	Δλ		40		nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 100 mA	ΤΚλρ		0.25		nm/K
Rise time	I <sub>F</sub> = 100 mA	t <sub>r</sub>		20		ns
Fall time	I <sub>F</sub> = 100 mA	t <sub>f</sub>		13		ns
Cut-off frequency	$I_{DC} = 70 \text{ mA}, I_{AC} = 30 \text{ mA pp}$	f <sub>c</sub>		18		MHz
Virtual source diameter		d		3.7		mm

#### Note

Tamb = 25 °C, unless otherwise specified



**TSHG8200** 

# High Speed Infrared Emitting Diode, Vishay Semiconductors 830 nm, GaAlAs Double Hetero

### **BASIC CHARACTERISTICS**

 $T_{amb} = 25 \ ^{\circ}C$ , unless otherwise specified

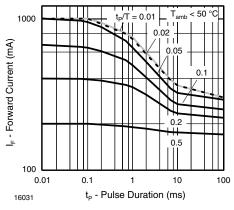


Fig. 3 - Pulse Forward Current vs. Pulse Duration

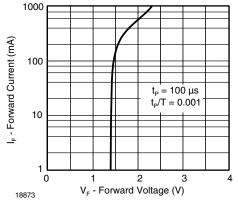


Fig. 4 - Forward Current vs. Forward Voltage

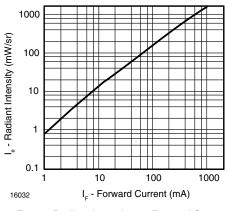


Fig. 5 - Radiant Intensity vs. Forward Current

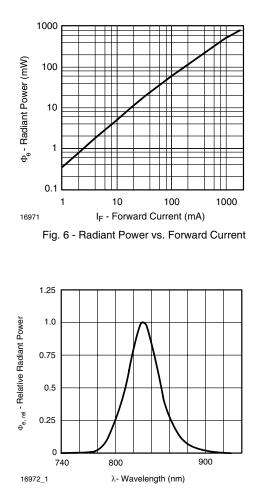


Fig. 7 - Relative Radiant Power vs. Wavelength

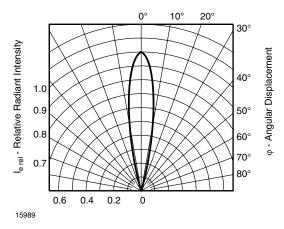


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

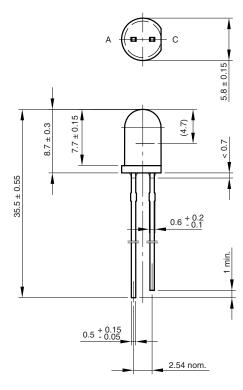
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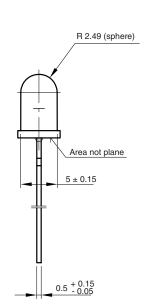
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## **PACKAGE DIMENSIONS** in millimeters







according to DIN specifications

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